

## Quarterly Reliability Monitoring Results

Quarters: Q3/2021 to Q4/2022

Based on structural similarity

Supplier	User Part Number					
Nexperia B.V.	PESD3V3X2UT					
Name of Laboratory	Part Description					
Assembly reliability labs	NXP ICN8 SMD package		Protection INDI			
Based on AEC-Q101 Test	Test Conditions	Duration	# Lots	# Quantity	# Rejects	
# E1	<b>TEST</b> Pre- and Post-Stress Electrical Test Tamb = 25 °C	N/A	see below	all parts	see below	
# A1	<b>PC</b> Preconditioning JESD22-A113 Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85% Reflow soldering	24 hours 168 hours 3 cycles	438	24630	0	
# B1	<b>HTRB</b> High Temperature Reverse Bias MIL-STD-750-1 M1038 Method A Tj = Tjmax, Vr = 100% of max. datasheet reverse voltage	1000 hours	21	1280	0	
# A4	<b>TC</b> Temperature Cycling JESD22-A104 -65 °C to Tjmax, not to exceed 150°C	1000 cycles	131	7760	0	
# A3 or	<b>UHAST</b> Unbiased HAST JESD22-A118 Tamb = 130 °C, RH = 85 %	96 hours	131	7760	0	
# A3 alt	<b>AC</b> Autoclave JESD22-A102 Tamb = 121 °C, RH = 100 % Pressure = 205 kPa (29.7 psia)					
# A2 alt	<b>H3TRB</b> High Humidity High Temperature Reverse Bias JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of rated reverse voltage <sup>[1]</sup>	1000 hours	131	7760	0	
# A5	<b>IOL</b> Intermittent Operating Life MIL-STD-750 Method 1037 ton = toff, devices powered to insure ΔTj = 100 °C for 15000 cycles	1000 hours	n.a.	n.a.	n.a.	
# C8	<b>RSH</b> Resistance to Solder Heat JESD22-A111 260 °C ± 5 °C	10 s	45	1350	0	
# C10	<b>SD</b> Solderability J-STD-002		111	1110	0	

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

### Calculation of FIT and MTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
NXP ICN8	Protection INDI	1280	0	3,32	3,01E+08

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